



# **Power Resistor, Thick Film Technology**



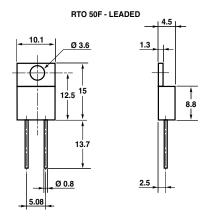
#### **FEATURES**

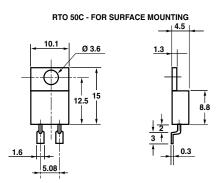
- 50 W at 25 °C Heatsink Mounted
- · Adjusted by sand trimming
- · Leaded or surface mount versions
- High power to size ratio
- Non inductive element



Because of the knowledge and experience in Thick Film technology, Vishay Sfernice has been able to develop a high power resistor in a TO 220 package called RTO 50. The special design of this component allows the dissipation of 50 W when mounted on a heatsink. The ohmic value is adjusted by sand trimming. This process does not generate hot spots as in laser trimming, which could lead to microcracks on each side of the curve. This process improves the reliability and the stability of the resistor and at the same time gives a good overload capability.

#### **DIMENSIONS** in millimeters





Only for RTO 50 version C = during surface mount soldering, the soldering temperature profile must not cause the metal tab of this device to exceed 220 °C.

#### **MECHANICAL SPECIFICATIONS**

**Mechanical Protection** Molded **Resistive Element** Thick Film

**Connections** Tinned copper alloy

Weight 2.2 g max.

**DIMENSIONS** 

**Standard Package** TO 220

Insulated Case

**ENVIRONMENTAL SPECIFICATIONS** 

**Temperature Range** - 55 °C to + 155 °C **Climatic Category** 55/155/156 Sealing Sealed container

Solder immersion IEC 60695-11-5

**Flammability** 2 applications 30 seconds

seperated by 60 seconds

ELECTRICAL SPECIFICATIONS				
Resistance Range	0.010 $\Omega$ to 1 M $\Omega$ serie E24			
Tolerances Standard	± 1 % to ± 10 %			
Dissipation and Associated	Onto a heatsink			
Thermal Resistance and Nominal Power	50 W at + 25 °C R <sub>TH</sub> (j-c): 2.6 °C/W free air: 2.25 W at + 25 °C			
Temperature Coefficient	See Performance table			
Standard (- 55 °C; + 150 °C)	± 150 ppm/°C			
Limiting Element Voltage	300 V			
Dielectric Strength MIL STD 202 (301)	2000 V <sub>RMS</sub> - 1 Minute 10 mA Max			
Insulation Resistance	$\geq 10^6  M\Omega$			
Inductance	≤ 0.1 μH			
Critical Resistance	1.8 kΩ			

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PERFORMANCE					
TESTS	CONDITIONS	TYPICAL DRIFTS			
Momentary Overload	EN 60115-1 2 Pr for R < 2 $\Omega$ 1.6 Pr for R $\geq$ 2 $\Omega$	± (0.25 % + 0.05 Ω)			
Rapid Temperature Change	EN 60115-1 60 068-2-14 5 cycles - 55 °C to + 155 °C	± (0.5 % + 0.05 Ω)			
Load Life	EN 60115-1 Pr at + 25 °C, 1000 h CEI 115_1	± (1 % + 0.05 Ω)			
Humidity (Steady State)	EN 60115-1 56 days RH 95 %	$\pm (0.5 \% + 0.05 \Omega)$			
Vibration	MIL STD 202 Method 204 C Test D	$\pm (0.2 \% + 0.05 \Omega)$			
Terminal Strength	MIL STD 202 Method 211 Test A1	± (0.2 % + 0.05 Ω)			

SPECIAL FEATURES						
Resistance Values		$\geq$ 0.01 $\Omega$	≥ 0.015 Ω	≥ 0.1 Ω	$\geq 0.5 \ \Omega$	
Tolerances		± 1 % at ± 10 %				
Temperature Coefficient	tandard	± 900 ppm/°C	± 700 ppm/°C	± 250 ppm/°C	± 150 ppm/°C	

#### **CHOICE OF THE HEATSINK**

The user must choose according to the working conditions of the component (power, room temperature).

Maximum working temperature must not exceed 155 °C. The dissipated power is simply calculated by the following ratio:

$$P = \frac{\Delta T}{[RTH(j-c) + RTH(c-a)]}(1)$$

P: expressed in W

T: difference between maximum working temperature and room temperature

(j-c): thermal resistance value measured between resistive layer and outer side of the resistor. It is the thermal R<sub>TH</sub>: resistance of the component: (Special Features Table)

(c-a): thermal resistance value measured between outer side of the resistor and room temperature. It is the thermal resistance of the heatsink itself (type, shape) and the quality of the fastening device

## Example:

R<sub>TH</sub>: (c-a) for RTO 50 power rating 13 W at ambient temperature + 30 °C

Thermal resistance R<sub>TH</sub> (j-c): 26 °C/W

Considering equation (1) we have:

$$\Delta T \leq$$
 155 °C - 30 °C  $\leq$  125 °C

$$R_{TH}(j-c) + R_{TH}(c-a) = \frac{\Delta T}{P} = \frac{125}{13} = 9.6 \text{ °C/W}$$
  
 $R_{TH}(c-a) \le 9.6 \text{ °C/W} - 2.6 \text{ °C/W} \le 7 \text{ °C/W}$ 

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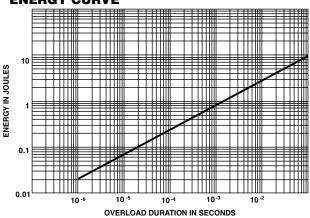


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#### **OVERLOADS**

The applied voltage must always be lower than the maximum overload voltage of 450 V. The values indicated on the graph below are applicable to resistors in air or mounted onto a heatsink.

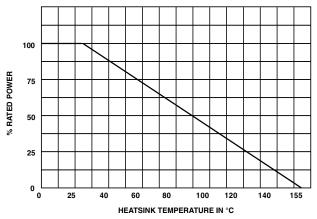
### **ENERGY CURVE**



#### **POWER RATING CHART**

The temperature of the heatsink should be maintained within the limits specified.

To improve the thermal conductivity, surfaces in contact should be coated with a silicone grease and the torque applied on the screw for tightening should be around 1 Nm.



#### **MARKING**

Model, Style, Resistance Value (in Ω), Tolerance (in %), Manufacturing Date, VISHAY trademark.

## **PACKAGING**

Tube of 50 units

ORDERING INFORMATION							
RTO	50	F	100K	± 1%	XXX	TU50	e1
MODEL	STYLE	CONNECTIONS	RESISTANCEVALUE	TOLERANCE	CUSTOM DESIGN	PACKAGING	LEAD (Pb)-free
		F: Radial Leads C: Surface Mount		± 1% ± 2% ± 5% ± 10%	Optional on request: special TCR, shap, etc.		

SAP PART NUMBERING GUIDELINES							
RTO	050	F	10 002	F	Т	E1	
MODEL	STYLE	CONNECTIONS	RESISTANCE VALUE	TOLERANCE	PACKAGING	LEAD (Pb)-free	

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Vishay

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